



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _A = +25°C
-12V	$18m\Omega@V_{GS} = -4.5V$	-7.2A
-120	$22m\Omega@V_{GS} = -2.5V$	-6.5A

Description and Applications

This MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Power Management Functions

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: V-DFN3020-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish NiPdAu Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.011 grams (Approximate)

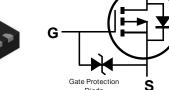


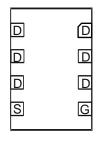






Bottom View





Equivalent Circuit

Bottom View Pin Configuration

Ordering Information (Note 4)

Top View

Part Number	Case	Packaging
DMP1022UWS-7	V-DFN3020-8	3000/Tape & Reel
DMP1022UWS-13	V-DFN3020-8	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

1F YM

1F = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2018	2019	2020	2021	2022	20	23	2024	2025	2026	2027	2028
Code	F	G	Н	I	J	ŀ	(L	M	N	0	Р
Month	Jan	Feb	Mar	Apr	May	Jun	Ju	I Au	у Ѕер	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings - P-CHANNEL MOSFET (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V_{DSS}	-12	V	
Gate-Source Voltage		V _{GSS}	±8	V	
Continuous Prain Correct (Note C) V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	-7.2 -5.3	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	I _D	-9.4 -7.6	А
Maximum Continuous Body Diode Forward Current	(Note 6)		Is	-1.8	Α
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%	6)	I _{DM}	-60	Α	
Avalanche Current (Note 7) L = 0.1mH		I _{AS}	-13	А	
Avalanche Energy (Note 7) L = 0.1mH		E _{AS}	9	mJ	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Total Power Dissipation (Note 5)		P _D	0.9	W	
The small Desistance Investigate Applicate (Nats 5)			135	°C/W	
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	78	C/VV	
Total Power Dissipation (Note 6)		P _D	1.4	W	
Thermal Resistance, Junction to Ambient (Note 6) Steady Statute t<10s		$R_{ hetaJA}$	90		
			52	°C/W	
Thermal Resistance, Junction to Case (Note 6)		$R_{\theta JC}$	15.6		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C	

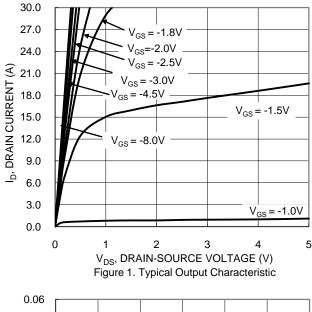
Electrical Characteristics - P-CHANNEL MOSFET (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 8)								
Drain-Source Breakdown Voltage	BV _{DSS}	-12	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$		
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-1	μA	V _{DS} = -10V, V _{GS} = 0V		
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$		
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage	V _{GS(TH)}	-0.35	_	-1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		
			12	18		$V_{GS} = -4.5V, I_D = -9A$		
Static Drain-Source On-Resistance	R _{DS(ON)}	_	15	22	mΩ	$V_{GS} = -2.5V, I_{D} = -8.5A$		
			23	28		$V_{GS} = -1.8V, I_D = -7.5A$		
Diode Forward Voltage	V_{SD}	_	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -8A$		
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance	C _{iss}	_	2847	_		V _{DS} = -4V, V _{GS} = 0V, f = 1.0MHz		
Output Capacitance	Coss	_	808	_	pF			
Reverse Transfer Capacitance	C _{rss}	_	731	_		I = I.OWINZ		
Gate Resistance	R _g	_	9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge	Qg	_	30	_		$V_{GS} = -5V, V_{DS} = -4V, I_D = -10A$		
Total Gate Charge	Qg	_	27	_	nC	V 4.5V V 4V		
Gate-Source Charge	Q _{gs}	_	4.1	_	nc	$V_{GS} = -4.5V, V_{DS} = -4V,$		
Gate-Drain Charge	Q _{gd}	_	6.4	_		$I_D = -10A$		
Turn-On Delay Time	t _{D(ON)}	_	20	_				
Turn-On Rise Time	t _R	_	28	_		$V_{DS} = -4V$, $V_{GS} = -4.5V$,		
Turn-Off Delay Time	t _{D(OFF)}	_	117	_	ns	$R_g = 1\Omega, I_D = -9.8A$		
Turn-Off Fall Time	t _F	_	93	_				
Bodyy Diode Reverse Recovery Time	t _{RR}	_	28	_	ns	1 000 11/14 1000///-		
Body Diode Reverse Recovery Charge	Q_{RR}	_	13	_	nC	$I_S = -9.8A$, $dI/dt = 100A/\mu s$		

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.
- 8. Short duration pulse test used to minimize self-heating effect.
 9. Guaranteed by design. Not subject to product testing.





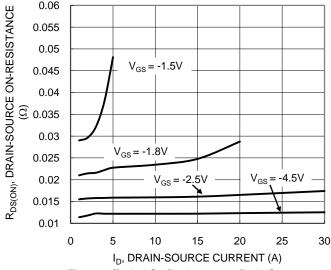


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

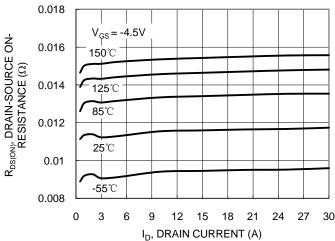


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

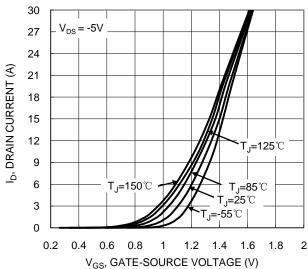
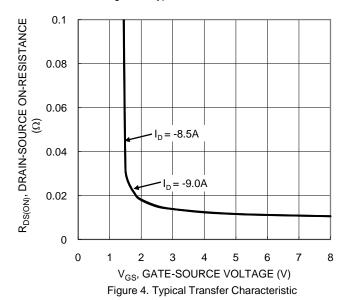


Figure 2. Typical Transfer Characteristic



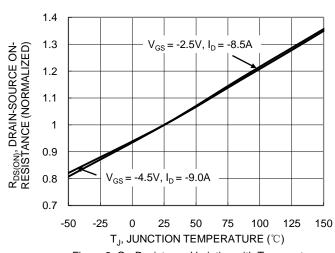
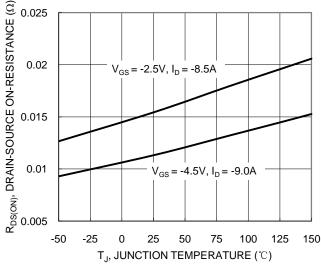
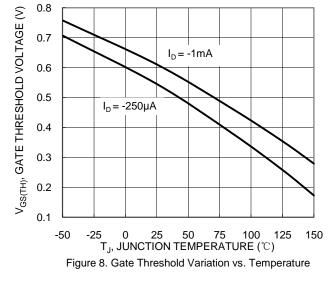


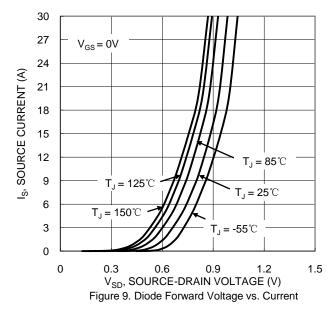
Figure 6. On-Resistance Variation with Temperature



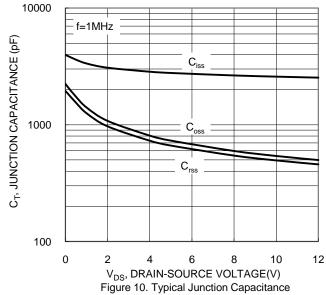


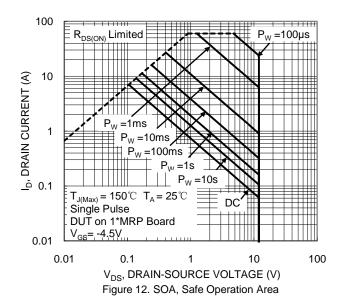






5 $V_{DS} = -4V, I_{D} = -10A$ $V_{GS}(V)$ 3 2 1 0 0 8 12 16 20 24 28 32 Qg (nC) Figure 11. Gate Charge





July 2018



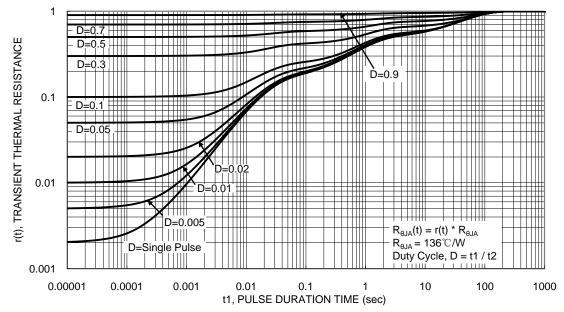


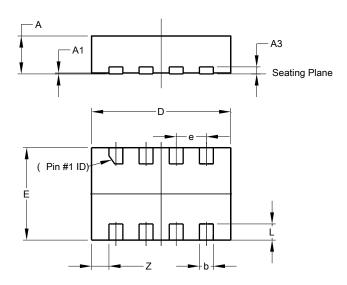
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

V-DFN3020-8

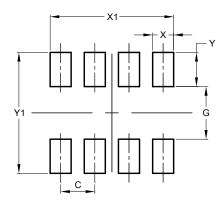


V-DFN3020-8							
Dim	Min	Min Max Typ					
Α	0.77	0.83	0.80				
A1	0	0.05	0.02				
A3	-	-	0.203				
b	0.25	0.35	0.30				
D	2.95	3.05	3.00				
е	-	-	0.65				
Е	1.95	2.05	2.00				
L	0.30	0.40	0.35				
Z	-	-	0.375				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

V-DFN3020-8



Dimensions	Value
Dillicitorio	(in mm)
С	0.650
G	1.000
Х	0.400
X1	2.350
Y	0.650
V1	2 300



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